

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	10/725,865	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/12 22:45
L2	443484	(bump ball contact) same (trace pattern (conductive adj line) pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/12 22:48
L3	35229	(substrate die wafer component chip (integrated adj circuit)) with (bond\$4 adj pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/12 22:52
L7	92	(bond\$4 adj pad) same ((dielectric insulat\$4) near3 wall)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/12 22:53
L8	76	3 and 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/12 22:53
L9	60	@ad <= "20021202" and 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/12 23:16
L10	2857	257/690-693.ccls.	USPAT	OR	OFF	2006/03/12 23:26
L11	20732	2 and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/12 23:16

EAST Search History

L12	751	10 and 11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/12 23:26
L13	686	@ad <= "20021202" and 12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/12 23:27
L14	765	257/690-693.ccls.	US-PGPUB	OR	OFF	2006/03/12 23:26
L15	220	14 and 11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/12 23:27
L16	113	@ad <= "20021202" and 15	US-PGPUB	OR	OFF	2006/03/12 23:32
L17	113	16 not 13	US-PGPUB	OR	OFF	2006/03/12 23:30
L18	4321	257/781.ccls. or 257/784.ccls. or 257/786.ccls. or 257/737-738.ccls. or 257/780.ccls.	USPAT	OR	ON	2006/03/13 00:07
L19	1564	18 and 11	USPAT	OR	ON	2006/03/12 23:31
L20	1366	@ad <= "20021202" and 19	USPAT	OR	OFF	2006/03/13 00:07
L21	1639	257/781.ccls. or 257/784.ccls. or 257/786.ccls. or 257/737-738.ccls. or 257/780.ccls.	US-PGPUB	OR	ON	2006/03/13 00:07
L22	0	@ad <= "20021202" and 21 and 11	USPAT	OR	OFF	2006/03/13 00:08
L23	0	@ad <= "20021202" and 21	USPAT	OR	OFF	2006/03/13 00:08
L24	287	@ad <= "20021202" and 21 and 11	US-PGPUB	OR	OFF	2006/03/13 00:08
L25	0	24 not 21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/13 00:08